

Table of contents

REFERENCES	4
1. Overview	5
2. Features	6
3. External Pins	8
3.1. TC358743AXBG BGA64 Pin Count Summary	10
3.2. Pin Layout	10
4. Package	11
5. Electrical Characteristics	12
5.1. Absolute Maximum Ratings	12
5.2. Operating Condition	12
5.3. DC Electrical Specification	13
6. Revision History	14
RESTRICTIONS ON PRODUCT USE	15
List of Figures Figure 1.1 TC358743AXBG System Overview	10
List of Tables	
Table 2.1 TC358743AXBG Power Consumption during typical of	perations7
Table 3.1 TC358743AXBG Functional Signal List Table 3.2 BGA64 Pin Count Summary	
	14

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REFERENCES

- 1. MIPI® D-PHYSM, "MIPI_D-PHY_specification_v01-00-00, May 14, 2009"
- 2. MIPI® CSI-2SM, "MIPI Alliance Standard for Camera Serial Interface 2 (CSI-2) Version 1.01 Revision Nov 2010"
- 3. VESA® Mobile Display Digital Interface Standard (Version 1.2, Type II)
- 4. I2C bus specification, version 2.1, January 2000, Philips Semiconductor

4 / 15 2019-01-23



1. Overview

The HDMI-RX to MIPI CSI-2-TX is a bridge device that converts HDMI stream to MIPI CSI-2 TX.

The current and next generation Application Processors and Baseband chips have been designed without video streaming input port except CSI-2 for Camcorder input. Smart Phone Processors are being used in several applications that required Video Input.

TC358743AXBG takes in HDMI input and converts to CSI-2 that looks like a Camcorder input.

TC358743AXBG System Overview block diagram is shown below.

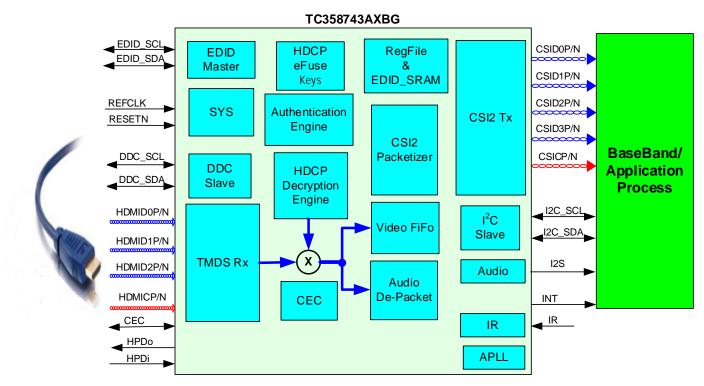


Figure 1.1 TC358743AXBG System Overview



2. Features

Below are the main features supported by TC358743AXBG.

- HDMI-RX Interface
 - → HDMI 1.4
 - Video Formats Support (Up to 1080P @60fps)
 - > RGB, YCbCr444: 24-bpp @60fps
 - > YCbCr422 24-bpp @60fps
 - Audio Supports
 - > Internal Audio PLL to track N/CTS value transmitted by the ACR packet.
 - 3D Support
 - Support HDCP (optional)
 - DDC Support
 - EDID Support
 - > Release A, Revision 1 (Feb 9, 2000)
 - > First 128 byte (EDID 1.3 structure)
 - First E-EDID Extension: 128 bytes of CEA Extension version 3 (specified in CEA-861-D)
 - > Embedded 1K-byte SRAM (EDID_SRAM)
 - Maximum HDMI clock speed: 165 MHz
 - Does not support Audio Return Path and HDMI Ethernet Channels
- CSI-2 TX Interface
 - ♦ MIPI CSI-2 compliant (Version 1.01 Revision 0.04 2 April 2009)
 - → Supports up to 1 Gbps per data lane
 - Video, Audio and InfoFrame data can be transmit over MIPI CSI-2
 - Supports up to 4 data lanes
- I²C Slave Interface
 - ♦ Support for Normal-mode (100 kHz) and Fast-mode (400 kHz)
 - ♦ Support Ultra Fast-mode (2 MHz)
 - ♦ Configure all TC358743AXBG internal registers
- Audio Output Interface

Either I2S or TDM Audio interface available (pins are multiplexed)

I2S Audio Interface

- Single data lane for stereo data
- → Support Master Clock mode only
- ♦ Support 16, 18, 20 or 24-bit data (depend on HDMI input stream)
- ♦ Support Left or Right-justify with MSB first
- ♦ Support 32 bit-wide time-slot only
- ♦ Output Audio Oversampling clock (256fs)

TDM (Time Division Multiplexed) Audio Interface

- → Fixed to 8 channels (depend on HDMI input stream)
- ♦ Support 32 bit-wide time slot only
- ♦ Support Master Clock mode only
- ♦ Support 16, 18, 20 or 24-bit PCM audio data word (depend on HDMI input stream)
- ♦ Output Audio Oversampling clock (256fs)



- InfraRed (IR)
 - ♦ Support NEC Infrared protocol
- System
 - ♦ Internal core has two power domains (VDDC1 and VDDC2)
 - VDDC1 is always on power domain
 - VDDC2 can be shut-off during deep sleep mode
- Power supply inputs

♦ Core and MIPI D-PHY: 1.2 V

♦ I/O: 1.8 V – 3.3 V

♦ HDMI: 3.3 V

♦ APLL:
3.3 V / 2.5 V

Power Consumption during typical operations

→ 720P: 0.48 W
 → 1080P @30fps: 0.48 W
 → 1080P @60fps: 0.54 W

Table 2.1 TC358743AXBG Power Consumption during typical operations

		VDDC1	VDDC2	VDDIO1	VDDIO2	VDDMIPI	AVDD33	AVDD12	AVDD25	Total	11:::4
		1.2	1.2	3.3	1.8	1.2	3.3	1.2	2.5	Power	Unit
720P	Current (A)	0.0	472	0	0.0009	0.0178	0.0879	0.0656	0.0128	400 47	m\\/
@60Frames	Power (W)	0.05	6664	0	0.0017	0.0214	0.2901	0.0787	0.032	480.47 mW	
1080P	Current (A) 0.0766	766	0	0.0009	0.0228	0.0881	0.0829	0.0128	543.19	mW	
@60Frames	Power (W)	0.09	192	0	0.0017	0.0274	0.2907	0.0995	0.032	543.19	IIIVV
Sleep 0x0002 =	Current (µA)	0.9	91	0.002	0.0430	0.0490	32.3700	0.3200	0.2	108.94	\^/
0x0002 = 0x0001	Power (µW)	1.0	92	0.0066	0.0774	0.0588	106.8210	0.3840	0.5	100.94	μW

Note:

- Attention about ESD. This product is weak against ESD. Please handle it carefully.



3. External Pins

TC358743AXBG resides in BGA64 pin packages. The following table gives the signals of TC358743AXBG and their function.

Table 3.1 TC358743AXBG Functional Signal List

Group	Pin Name	I/O	Init. (O)	Туре	Function	Voltage Supply	Note
	RESETN	ı	1	Sch	System reset input, active low	VDDIO2	1.8V -3.3V
System:	REFCLK	- 1	-	N	Reference clock input (27/26 MHz or 42 MHz)	VDDIO2	1.8V -3.3V
Reset & Clock (4)	TEST	I	-	N	TEST mode select 0: Normal mode 1: Test mode	VDDIO2	1.8V -3.3V
	INT	0	L	N	Interrupt Output signal – active high (Level)	VDDIO2	1.8V -3.3V
	CSICP	-	Η	MIPI-PHY	MIPI-CSI-2 clock positive	VDD_MIPI	1.2V
	CSICN	-	Η	MIPI-PHY	MIPI-CSI-2 clock negative	VDD_MIPI	1.2V
	CSID0P	-	Η	MIPI-PHY	MIPI-CSI-2 Data 0 positive	VDD_MIPI	1.2V
	CSID0N	-	Η	MIPI-PHY	MIPI-CSI-2 Data 0 negative	VDD_MIPI	1.2V
CSI-2 TX	CSID1P	-	Η	MIPI-PHY	MIPI-CSI-2 Data 1 positive	VDD_MIPI	1.2V
(10)	CSID1N	-	Η	MIPI-PHY	MIPI-CSI-2 Data 1 negative	VDD_MIPI	1.2V
	CSID2P		Η	MIPI-PHY	MIPI-CSI-2 Data 2 positive	VDD_MIPI	1.2V
	CSID2N	-	Н	MIPI-PHY	MIPI-CSI-2 Data 2 negative	VDD_MIPI	1.2V
	CSID3P	-	Н	MIPI-PHY	MIPI-CSI-2 Data 3 positive	VDD_MIPI	1.2V
	CSID3N	•	Н	MIPI-PHY	MIPI-CSI-2 Data 3 negative	VDD_MIPI	1.2V
	HDMICP	•	-	HDMI-PHY	HDMI Clock channel positive	AVDD33	3.3V
	HDMICN	•	-	HDMI-PHY	HDMI Clock channel negative	AVDD33	3.3V
	HDMID0P	-	-	HDMI-PHY	HDMI Data 0 channel positive	AVDD33	3.3V
HDMI-RX	HDMID0N	-	-	HDMI-PHY	HDMI Data 0 channel negative	AVDD33	3.3V
(8)	HDMID1P	-	-	HDMI-PHY	HDMI Data 1 channel positive	AVDD33	3.3V
	HDMID1N	-	-	HDMI-PHY	HDMI Data 1 channel negative	AVDD33	3.3V
	HDMID2P	-	-	HDMI-PHY	HDMI Data 2 channel positive	AVDD33	3.3V
	HDMID2N	-	-	HDMI-PHY	HDMI Data 2 channel negative	AVDD33	3.3V
DDC	DDC_SCL	Ю	-	N (Note2)	DDC Slave Clock	VDDIO1	3.3V (Note1)
(2)	DDC_SDA	10	-	N (Note2)	DDC Slave data	VDDIO1	3.3V (Note1)
EDID	EDID_SCL	10	-	N (Note2)	EDID Master Clock	VDDIO2	1.8V -3.3V
(2)	EDID_SDA	10	-	N (Note2)	EDID Master Data	VDDIO2	1.8V -3.3V
CEC	CEC	10	-	N (Note2)	CEC signal	VDDIO1	3.3V
HPD	HPDI	ı	-	N	Hot Plug Detect Input	VDDIO1	3.3V (Note1)
(2)	HPDO	0	L	N	Hot Plug Detect Output	VDDIO1	3.3V
(=)	A_SCK	0	L	N	I2S/TDM Bit Clock signal	VDDIO1	1.8V -3.3V
Audio	A_WFS	0	L	N	I2S Word Clock or TDM Frame Sync signal	VDDIO2	1.8V -3.3V
(4)	A_WIS	0	L	N	I2S/TDM data signal	VDDIO2	1.8V -3.3V
(4)	A_OSCK	0	L	N	Audio Oversampling Clock	VDDIO2	1.8V -3.3V
IR	IR	-		Sch	Infrared signal	VDDIO2	1.8V -3.3V
	I2C_SCL	10	-	N (Note2)	I ² C serial clock	VDDIO2	1.8V -3.3V
I2C (2)	I2C_SDA	10	-	N (Note2)	I ² C serial data	VDDIO2	1.8V -3.3V
(2)	BIASDA	0	L	-	BIAS signal Connect to AVSS through 0.1µF when not used	-	-
APLL	DAOUT	0	Н	-	Audio PLL clock Reference Output clock Please leave open when not used	-	-
(4)	PCKIN	I	-	-	Audio PLL Reference Input clock Connect to AVSS through 0.1µF when not used	-	-
	PFIL	0	L	-	Audio PLL Low Pass Filter signal Connect to AVSS through 0.1µF when not used	-	-



Group	Pin Name	I/O	Init. (O)	Туре	Type Function		Note
	VDDC1, VDDC2	-	-	-	VDD for Internal Core (3)	-	1.2V
	VDDIO1	-	-	-	VDDIO1 IO power supply (1)	-	3.3V
POWER	VDDIO2	-	-	-	VDDIO2 IO power supply (1)	-	1.8V -3.3V
(12)	VDD_MIPI	-	-	-	VDD for the MIPI CSI-2 (2)	-	1.2V
	AVDD12	-	-	-	HDMI Phy 1.2 V power supply (2)	-	1.2V
	AVDD33	-	-	-	HDMI Phy 3.3 V power supply (2)	-	3.3V
	AVDD25	-	-	-	APLL 2.5 V power supply (1)	-	2.5V
Ground (10)	VSS	ı	ı	-	Ground	-	-
Misc	REXT	-	-	-	External Reference Resistor, Please connect to AVDD33 with a 2 $k\Omega$ resistor (± 1%)	-	-
(2)	VPGM	-	-	-	eFuse program power supply, please tie to ground	-	-

Total 64 pins

Note1: These IO are 5 V tolerant.

Note2: Bi-directional IO with Schmitt triggered input.

Buffer Type Abbreviation:

N: Normal IO

N_{PD}: Normal IO with weak Internal Pull-DownN_{PU}: Normal IO with weak Internal Pull-Up

FS-SOD: Failed Safe Pseudo open-drain output, Schmitt input

FS: Failed Safe IO
Sch: Schmitt input buffer

MIPI-PHY: front-end analog IO for CSI-2 HDMI-PHY: front-end analog IO for HDMI



3.1. TC358743AXBG BGA64 Pin Count Summary

Table 3.2 BGA64 Pin Count Summary

Group Name	Pin Count
System	4
CSI-2 TX	10
HDMI-RX	8
DDC	2
EDID	2
CEC	1
HPD	2
Audio	4
IR	1
I2C	2
APLL	4
POWER	12
Ground	10
Misc	2
TOTAL	64

3.2. Pin Layout

A1	A2	A3	A4	A5	A6	A7	A8
REXT	VSS	VPGM	BIASDA	DAOUT	PFIL	CSID3N	CSID3P
B1	B2	B3	B4	B5	B6	B7	B8
AVDD33	AVDD12	INT	IR	AVDD25	PCKIN	CSID2N	CSID2P
C1	C2	C3	C4	C5	C6	C7	C8
HDMICP	HDMICN	VDDC2	VSS	VSS	VDD_MIPI	CSICN	CSICP
D1	D2	D3	D4	D5	D6	D7	D8
HDMID0P	HDMID0N	AVDD12	VSS	VSS	VSS	CSID1N	CSID1P
E1	E2	E3	E4	E5	E6	E7	E8
HDMID1P	HDMID1N	VSS	VSS	TEST	VSS	CSID0N	CSID0P
F1	F2	F3	F4	F5	F6	F7	F8
HDMID2P	HDMID2N	AVDD33	VDDIO1	VDDC2	VDD_MIPI	A_SCK	A_SD
G1	G2	G3	G4	G5	G6	G7	G8
CEC	VDDC1	DDC_SDA	I2C_SDA	RESETN	EDID_SDA	A_WFS	A_OSCK
H1	H2	H3	H4	H5	H6	H7	H8
HPDO	HPDI	DDC_SCL	I2C_SCL	REFCLK	EDID_SCL	VDDIO2	VSS

Figure 3.1 TC358743AXBG 64-Pin Layout (Top View)



4. Package

The packages for TC358743AXBG are described in the figures below.

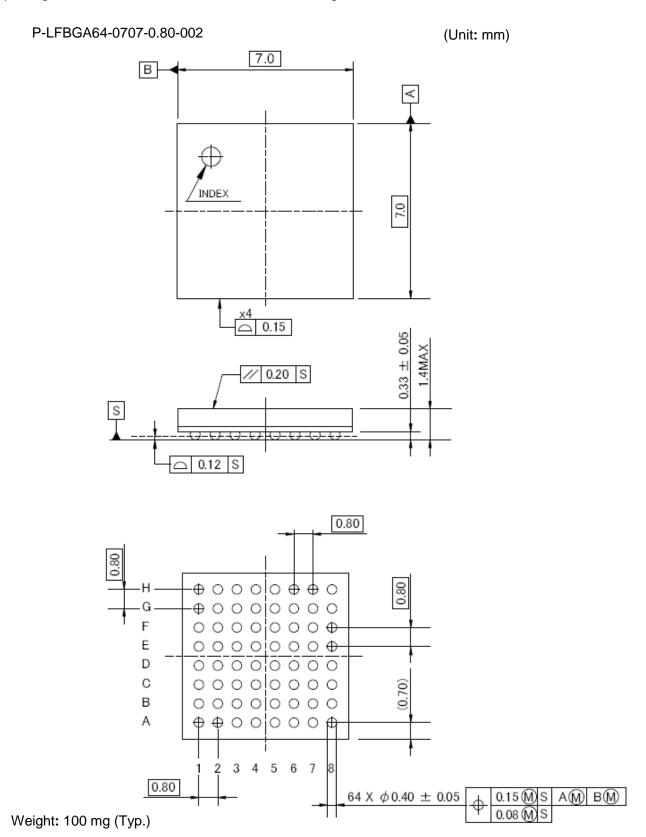


Figure 4.1 TC358743AXBG package (64 pins)



5. Electrical Characteristics

5.1. Absolute Maximum Ratings

VSS = 0 V reference

Parameter	Symbol	Rating	Unit
Supply voltage (1.8 V – Digital IO)	VDDIO	-0.3 to +3.9	V
Supply voltage (1.2 V – Digital Core)	VDDC	-0.3 to +1.8	V
Supply voltage (1.2 V – MIPI CSI PHY)	VDD_MIPI	-0.3 to +1.8	V
Supply voltage (3.3 V – HDMI RX Phy)	AVDD33	-0.3 to +3.9	V
Supply voltage (1.2 V – HDMI RX Phy)	AVDD12	-0.3 to +1.8	V
Supply voltage (2.5 V – APLL)	AVDD25	-0.3 to +2.75	V
Input voltage (CSI IO)	V _{IN_CSI}	-0.3 to VDD_MIPI + 0.3	V
Output voltage (CSI IO)	V _{OUT_CSI}	-0.3 to VDD_MIPI + 0.3	V
Input voltage (Digital IO)	V _{IN_IO}	-0.3 to VDDIO + 0.3	V
Output voltage (Digital IO)	V _{OUT_IO}	-0.3 to VDDIO + 0.3	V
Output voltage (APLL)	V _{OUT_APLL}	-0.3 to AVDD25 + 0.3	V
Junction temperature	Tj	125	°C
Storage temperature	Tstg	-40 to +125	°C

5.2. Operating Condition

VSS = 0 V reference

Parameter	Symbol	Min	Тур.	Max	Unit
Supply voltage (1.8/3.3 V – Digital IO)	VDDIO2	1.65	1.8	3.6	V
Supply voltage (3.3 V – HDMI Digital IO)	VDDIO1	3.0	3.3	3.6	V
Supply voltage (1.2 V – Digital Core)	VDDC	1.1	1.2	1.3	V
Supply voltage (1.2 V – MIPI CSI PHY)	VDD_MIPI	1.1	1.2	1.3	V
Supply voltage (2.5 V – APLL)	AVDD25	2.25	2.5	2.75	V
Operating temperature (ambient temperature with voltage applied)	Та	-30	25	85	ů
Supply Noise Voltage	VSN	-	-	0.1	Vpp
Supply voltage (3.3 V – HDMIRX PHY)	AVDD33	3.135	3.3	3.465	V
Supply Noise Voltage for AVDD33	VSN33	-	-	0.08	Vpp
Supply voltage (1.2 V – HDMIRX PHY)	AVDD12	1.15	1.2	1.25	V
Supply Noise Voltage for AVDD12	VSN12	-	-	0.04	Vpp



5.3. DC Electrical Specification

Parameter	Symbol	Min	Тур.	Max	Unit
Input voltage, High level input Note1	V _{IH}	0.7 x VDDIO	-	VDDIO	V
Input voltage, Low level input Note1	V _{IL}	0	-	0.3 x VDDIO	V
Input voltage High level CMOS Schmitt Trigger Note1, Note2	V _{IHS}	0.7 x VDDIO	-	VDDIO	V
Input voltage Low level CMOS Schmitt Trigger Note1, Note2	V _{ILS}	0	-	0.3 x VDDIO	V
Output voltage High level Note1, Note2	V _{OH}	0.8 x VDDIO	-	VDDIO	V
Output voltage Low level Note1, Note2	V _{OL}	0	-	0.2 x VDDIO	V
Input leak current, High level (Condition: V _{IN} = +VDDIO, VDDIO = 3.6 V)	I _{ILH1} (Note3)	-10	-	10	μA
Input leak current, Low level (Condition: $V_{IN} = 0 \text{ V}$, VDDIO = 3.6 V)	I _{ILL1} (Note4)	-10	-	10	μΑ

Note1: Each power source is operating within operating condition.

Note2: Current output value is specified to each IO buffer individually. Output voltage changes with

output current value.

Note3: Normal pin or Pull-up IO pin applied VDDIO supply voltage to Vin (input voltage)

Note4: Normal pin applied VSS (0 V) to Vin (input voltage)

2019-01-23



6. Revision History

Table 6.1 Revision History

Revision	Date	Description
0.62	2016-01-05	Newly released
1.0	2017-10-26	Added comment to HDCP in Features. Changed header, footer and the last page. Changed corporate name.
1.1	2019-01-23	Modified descriptions of service mark and trademark. Added trademarks and service marks. Modified "Note" number in section 5.3. Corrected weight. Revised the last page "RESTRICTIONS ON PRODUCT USE" and added URL.



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 OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.

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